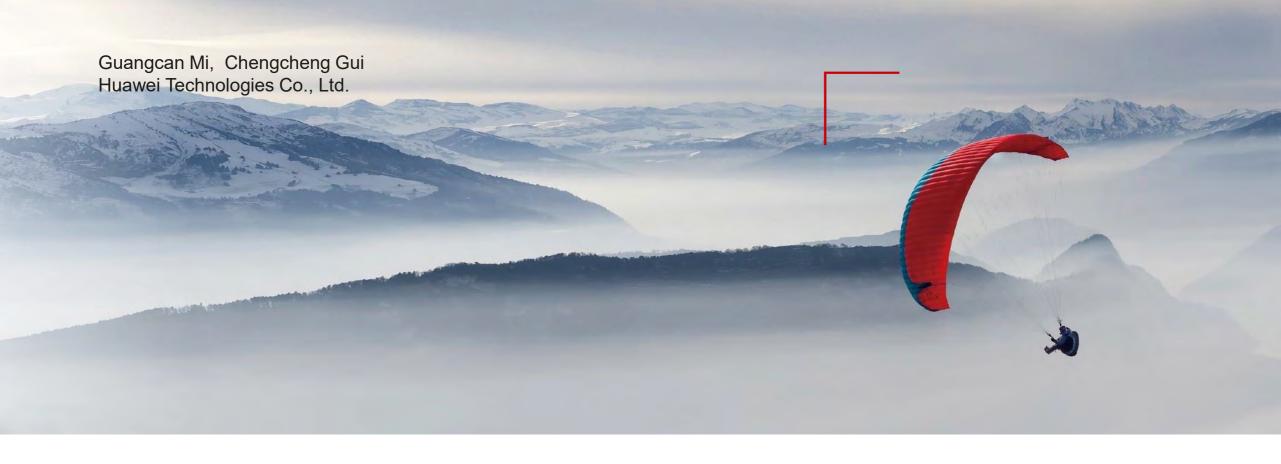
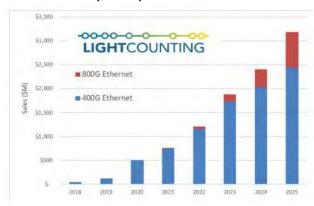
LN-on-Insulator Modulator Technology for B400G Ethernet Application



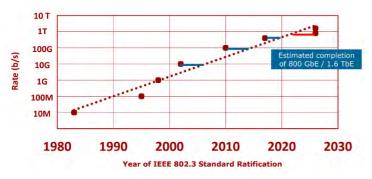


Recap: B400GE Application

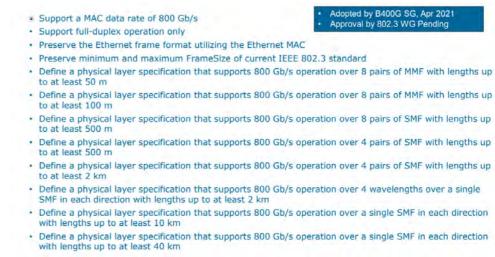
In Vlad Kozlov's contribution <u>kozlov b400g 01_210211</u>, market projection was reviewed. B400GE, starting with 800GE, will start to pick up in 2022 and later.



In the Chair's report in March, <u>dambrosia_b400g_01_210301</u>, the below timeline projection of B400GE standard development was discussed.



Summarized in the Chair's report in April, <u>dambrosia_b400g_02_210426</u>, the group has adopted the below objectives of physical layer specification

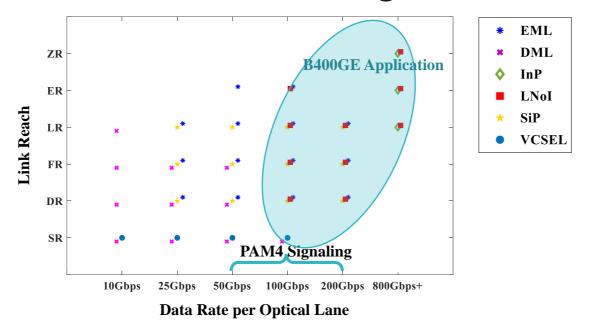


- 100Gbps per optical lane at DR (current optical PMDs defined by cu)
- 200Gbps per optical lane at DR/FR, maybe LR
- 800Gbps coherent is a potential candidate for LR and ER
- Technical feasibility of B400GE in terms of signaling, BER, FEC are being actively discussed.
- This contribution discusses a possible technology for the new optical PMDs at higher data rates.

Do/Will we have a good selection of modulator technologies for B400GE Application? Technical variety is helpful for building a healthy ecosystem and continuously driving down the cost.



Choices of Modulator Technologies for Ethernet Application



- Reported LNoI MZM modulator can easily reach and above 60GHz EO bandwidth, along with good linearity, and low insertion loss
 - Leaves room to move around and compromise among other components used in the link
- One technology serves for the two use cases of B400GE, both IM-DD and coherent
 - Less investment in fabrication
 - Bring down the Cost/chip by mass production
 - Brings benefits of cost down approach
- Typical Bandwidth of SiP MZM modulators <40GHz, requires stronger pre-emphasics/EQ/CTLE/FEC to work at 200Gbps/lane, that
 means higher power, longer latency



LNoI modulator is a new but old technology

- Commercial LN modulator companies launching LNTF technologies
 - V. Stenger, A. Pollick, and C. Acampado, "Integrable Thin Film Lithium Niobate (TFLN™) on Silicon Electro-optic Modulators," in Optical Fiber Communication Conference (OFC) 2019, OSA Technical Digest (Optical Society of America, 2019), paper Tu2H.6.
- Mass production of LNoI Wafer @ 6" now, and moving to 8"
- Industries investing on pre-Research and R&D of LNoI
- Key technology IP holders founding startups
 - Some have secured VC investment
- Foundry is not overlooking the potential of LNol
 - Reza Safian, Min Teng, Leimeng Zhuang, and Swapnajit Chakravarty, "Foundry-compatible thin film lithium niobate modulator with RF electrodes buried inside the silicon oxide layer of the SOI wafer," Opt. Express 28, 25843-25857 (2020)
- Reuse of most current eco system and PDA flow of current photonic technologies, i.e., SiP and InP
 - Very well known physical and electromagnetic theory
 - > Same design flow and simulation software
 - > Same fabrication process flow and major instrument
 - Same packaging process as SiP

Therefore, it is not too optimistic to predict LNoI technology can be commercially ready in time with the vast deployment of 200G-PAM4 and B400G coherent modules. It then provides a strong candidate as a cost effective component for B400GE application.

Homogeneous LNoI modulator

Homogeneous Approach

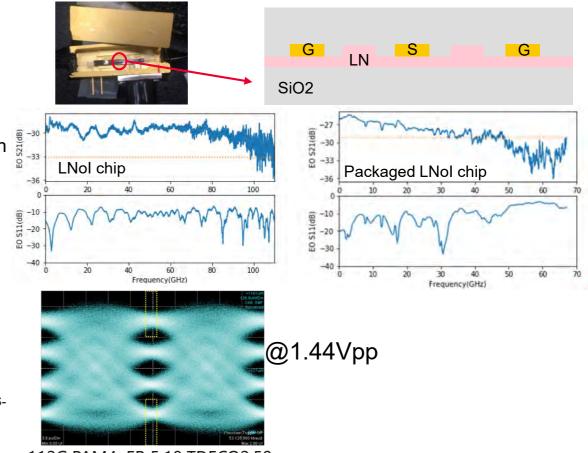
The modulator device comprises of LNoI

- Coupling Loss to SMF<0.6dB, Modulator loss~2.5dB
- 3-dB EO bandwidth >100GHz
- With its low loss, high bandwidth and good linearity, it is possible to reach for 200GPAM4 10km application
- Very low loss EO phase shifter allows high modulation efficiency, <1.1V driving voltage achievable
- ODSP direct drive application
- Reuse of CMOS/SiP fabrication facility

Components are being optimized for practical product

Further reading on the LNoI modulator technology –homogeneous approach can be found in

Wang, C., Zhang, M., Chen, X. *et al.* Integrated lithium niobate electro-optic modulators operating at CMOS-compatible voltages. *Nature* **562**, 101–104 (2018). https://doi.org/10.1038/s41586-018-0551-y Yuan, S., Hu, C., Pan, An.et al. Photonic devices based on thin-film lithium niobated on insulator. 2021 J. Semicond. **42** 041304. https://iopscience.iop.org/article/10.1088/1674-4926/42/4/041304/meta



112G PAM4 ER 5.18 TDECQ2.59

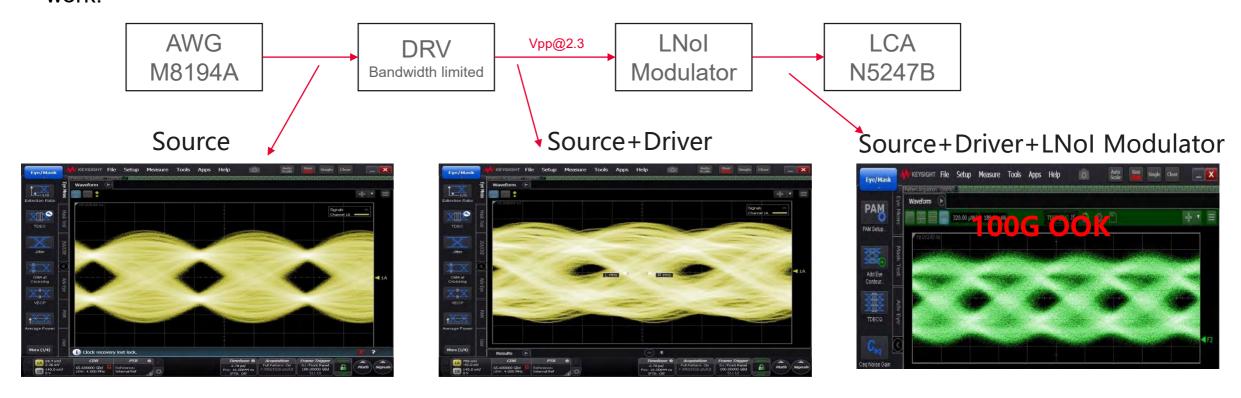
With Permission of Chengcheng Gui, Huawei

The shown results are the outcome of preliminary laboratory work, and do not represent the best optimized. This presentation is to show technical feasibility of LNoI in B400GE application, and should not be interpreted as indication of product performance or technological preference of Huawei



Homogeneous LNoI modulator

- Limited by the testing instrument, we were only able to test the modulator against 100G OOK signal at the time, but from the S21 response and 100G-OOK eye diagram, the modulator could work for 200G-PAM4 signaling.
- Improvement on packaging and test apparatus is in progress and 200G-PAM4 testing will be involved in future work.



The shown results are the outcome of preliminary laboratory work, and do not represent the best optimized. This presentation is to show technical feasibility of LNoI in B400GE application, and should not be interpreted as indication of product performance or technological preference of Huawei.



Hybrid Si/SiN/LNoI modulator

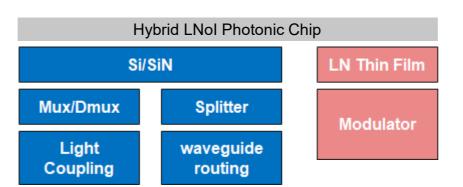
Hybrid Integration Approach

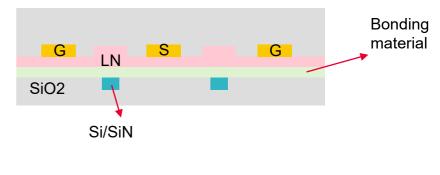
Integration with Silicon/SiN

- Optical Mode transfers from Si/SiN waveguide to LN waveguide where modulation happens
 - A coherent modulator was reported working with up to 80GBd 16QAM signal
- Si/SiN waveguide allow more compact chip size when more complicated systems are needed.
 - Mux/Demux
 - Waveguide routing
- Added BEOL fabrication
 - Leverage exising SiP Foundry

Further reading on the LNoI modulator technology -hybrid integration approach can be found in

- Xu, M., He, M., Zhang, H. *et al.* High-performance coherent optical modulators based on thin-film lithium niobate platform. *Nat Commun* **11**, 3911 (2020).
- He M, Xu M, Ren Y, et al. High-performance hybrid silicon and lithium niobate Mach–Zehnder modulators for 100 Gbit s⁻¹ and beyond[J]. Nature Photonics, 2019, 13(5): 359-364.







Breakthrough on Fabrication Tech.



Growing PIC
Design
EcoSystem



Fast Iteration of Component R&D, matured with B400GE

Intrinsically
High Bandwidth
Low Loss LNoI MOD



FEC
Packaging
DRV/DSPs
Link Parameters



More Data to Support the Development of B400GE



Future work to be done

- Test of 200G signaling using improved modulator and packaging
 - > Investigate 200G PAM4 link for at least 2km, and investigate its capability of operation over up to 10km link
 - > Test against various working condition
- Demonstration of Coherent modulator @130GBd 16QAM for 800Gbps
 - > Investigate Optical link properties
 - > Investigate Optical link capabilities on OSNR and BER to facilitate discussion on BER and FEC



Thank you.

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